## 506550973 03/12/2021

# PATENT ASSIGNMENT COVER SHEET

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 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
MASAAKI KAMIYA	10/11/2019
RYUJI ARIYOSHI	10/11/2019

### **RECEIVING PARTY DATA**

Name:	INTERCHIP CO., LTD.
Street Address:	2-5-1, SAKURADAI, CHIBA
City:	SHIROI-SHI
State/Country:	JAPAN
Postal Code:	270-1472

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16301902

#### **CORRESPONDENCE DATA**

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Correspondent Name: THE WEBB LAW FIRM 420 FT. DUQUESNE BLVD

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Address Line 4: PITTSBURGH, PENNSYLVANIA 15222

ATTORNEY DOCKET NUMBER: 8297-1807722

NAME OF SUBMITTER: RYAN J. MILLER, REG. NO. 56,236

SIGNATURE: /Ryan J. Miller/

DATE SIGNED: 03/12/2021

**Total Attachments: 2** 

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PATENT 506550973 REEL: 055573 FRAME: 0166

	INTERNATIONAL
Application No.	16/301,902
Attorney Docket N	o. <u>8297-1807722</u>

## **ASSIGNMENT**

WHEREAS, as a below named inventor, I have invented certain new and useful
improvements in
THERMOSTATIC OVEN TYPE ELECTRONIC INSTRUMENT
(Invention Title)
for which I have this day executed an application for a United States Patent (hereinafter "said application").  AND/OR
phonous y
X for which an application for a United States Patent was filed on 05/16/2017 (mm/dd/yyy) and bears Application Number 16/301,902 (hereinafter "said application").  AND/OR
for which an international patent application was filed under the Patent Cooperation Treat on 05/16/2017 (mm/dd/yyyy), bearing Application No. PCT/JP2017/018372 (hereinafter "said application").
AND, WHEREAS, Interchip Co., Ltd., a corporation of Japan, having a place of business at 2-5-1, Sakuradai, Shiroi-shi, Chiba 270-1472, Japan, hereinafter called the "assignee", is desirous of acquiring the entire right, title, and interest in and to said application and the inventions and improvements therein disclosed.
NOW, THEREFORE, for good and valuable consideration paid to me by said assignee, the receipt of which is hereby acknowledged, I as the inventor or as one of the inventors hereinafter the assignor(s), do hereby assign, sell and transfer unto said assignee the full and evaluative right title and interest is and to said application and the inventions and improvements

NOW, THEREFORE, for good and valuable consideration paid to me by said assignee, the receipt of which is hereby acknowledged, I as the inventor or as one of the inventors, hereinafter the assignor(s), do hereby assign, sell and transfer unto said assignee the full and exclusive right, title and interest in and to said application and the inventions and improvements therein disclosed for the United States and all foreign countries, including rights of priority under the International Convention of Paris (1883) as amended, and any Letters Patent which may issue therefor in the United States and all foreign countries and all divisions, reissues, continuations, continuations-in-part, renewals and/or extensions thereof. Such assignment extends to the full ends of the terms of these applications and patents as fully and entirely as the same would have been held and enjoyed by me had this Assignment not been made.

I covenant that I am the lawful owner(s) of said application, inventions and improvements, that the same are unencumbered, that no license has been granted to make, use or vend the said inventions or improvements or any of them, and that I have the full right to make this Assignment.

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4E42828-Assignment for signature (002)

	INTERNATIONAL
Application No.	16/301,902
Attorney Docket	No. <u>8297-1807722</u>

And for the consideration aforesaid, I agree individually and, if applicable, jointly that I will communicate to said assignee or the representatives thereof any facts known to me respecting said inventions and improvements, and will, upon request but without expense to me, testify in any legal proceedings, sign all lawful papers, execute all divisional, reissue, continuation, continuation-in-part, renewal and/or extension applications, make all rightful oaths, and generally do all other and further lawful acts deemed necessary or expedient by said assignee or by counsel for said assignee to assist or enable said assignee to obtain and enforce full benefits from the rights and interests herein assigned. This Assignment shall be binding upon my heirs, executors, administrators and/or assigns, and shall inure to the benefit of the heirs, executors, administrators, successors and/or assigns, as the case may be, of said assignee.

1. FULL NAME OF ASSIGNOR:  Masaaki KAMIYA	RESIDENCE: Shiroi-shi, Japan
EXECUTED this // day of October	, 2019 Mass Growny SIGNATURE
	SIGNATURE
WITNESS:	
2. FULL NAME OF ASSIGNOR: Ryuji ARIYOSHI	RESIDENCE: Shiroi-shi, Japan
EXECUTED this 11 day of October	, 2019  Ryuji Ariyushi SIGNATURE
WITNESS	SKRATOKE
	Bi.
Checked Box indicates additional page	ge(s) for inventor signatures.
4E42828-Assignment for signature (002) Pag	e 2 of 2

REEL: 055573 FRAME: 0168

**PATENT** 

**RECORDED: 03/12/2021**